



DC Input
Optocoupler

DESCRIPTION

The SDD601 consists of a photo Darlington transistor optically coupled to a light emitting diode. Optical coupling between the input LED and output photo Darlington transistor allows for high isolation levels while maintaining low-level DC signal control capability. The SDD601 provides an optically isolated method of controlling many interface applications such as telecommunications, industrial control and instrumentation circuitry.

FEATURES

- High current transfer ratio (CTR:MIN 500%)
- High input-to-output isolation package (5000 Vrms)
- Compact dual-in-line package

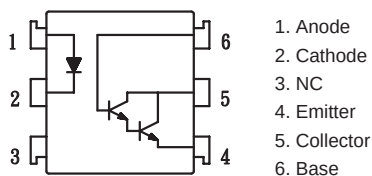
APPLICATIONS

- System appliances, measuring instruments
- Industrial robots
- Copiers, automated vending machines
- Signal transmission between varying circuits
- Telephone sets
- Fax machines
- Interface with various power supply circuits
- Numerical control machines

OPTIONS/SUFFIXES

- -S Surface Mount Option
- -TR Tape and Reel Option

SCHEMATIC DIAGRAM



MAXIMUM RATINGS

PARAMETER	UNIT	MIN	TYP	MAX
Forward Current (If)	mA			50
Peak Forward Current	A			1
Reverse Voltage	V			6
Total Power Dissipation	mW			200
Storage Temperature	°C	-55		125
Operating Temperature	°C	-40		100

APPROVALS

- UL and C-UL Approved File# E201932



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ELECTRICAL CHARACTERISTICS - 25°

PARAMETER	UNIT	MIN	TYP	MAX	TEST CONDITIONS
INPUT SPECIFICATIONS					
LED Forward Voltage	V		1.2	1.4	If = 20mA
Peak Forward Voltage	V			3.5	Ifm=0.5A
OUTPUT SPECIFICATIONS					
Collector-Emitter Breakdown Voltage	V			30	
Collector-Base Voltage	V			30	
Dark Current	μ A			0.1	Vce = 10V, If=0
Floating Capacitance	p F		0.6	1	Vce = 0V, f=1.0MHz
Saturation Voltage	V			1.5	If = 8mA, Ic = 2mA
Current Transfer Ratio	%	500			If = 1mA, Vce = 2V
Rise Time	μ s		5	30	Ic = 2mA, Vce = 10V, Rc = 100 ohms
Fall Time	μ s		60	80	Ic = 2mA, Vce = 10V, Rc = 100 ohms
COUPLED SPECIFICATIONS					
Isolation Voltage	V	5000			T = 1 minute
Isolation Resistance	G Ω	50			
Cut off Frequency	k H z		7		Ic = 2mA, Vcc = 5V, Rc = 100 ohms

Fig.1 Forward Current vs. Ambient Temperature

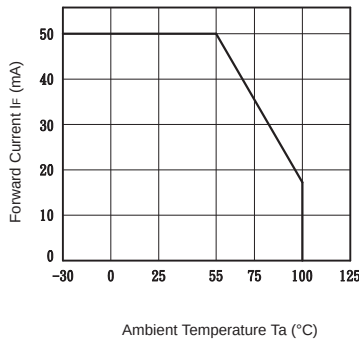


Fig.2 Collector Power Dissipation vs. Ambient Temperature

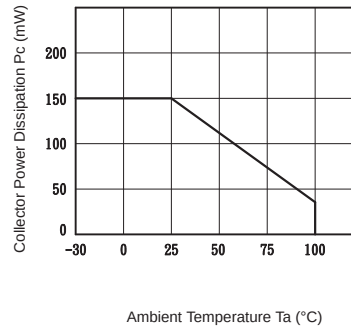


Fig.3 Peak Forward Current vs. Duty Ratio

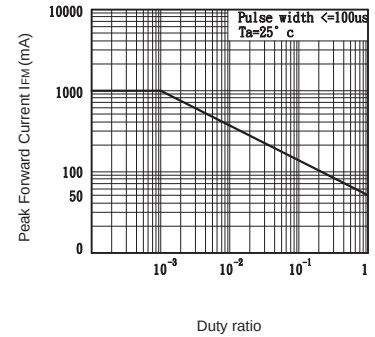


Fig.4 Forward Current vs. Forward Voltage

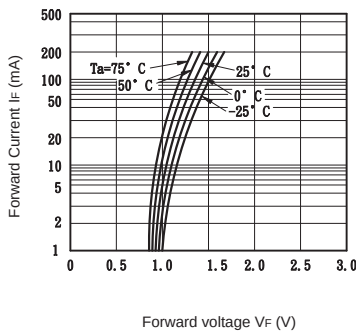


Fig.5 Current Transfer Ratio vs. Forward Current

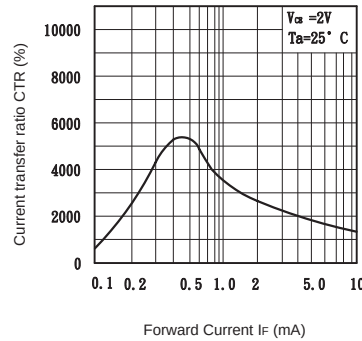


Fig.6 Collector Current vs. Collector-emitter Voltage

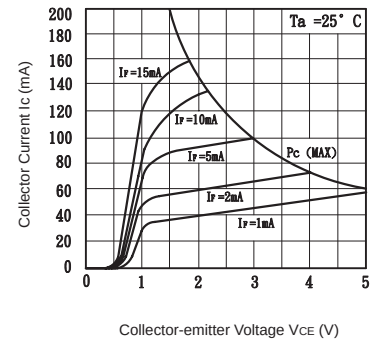


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

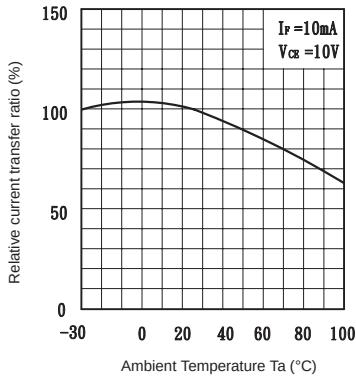


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

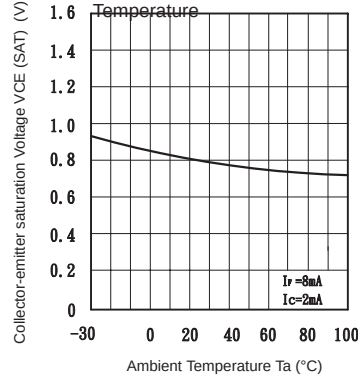


Fig.9 Collector Dark Current vs. Ambient Temperature

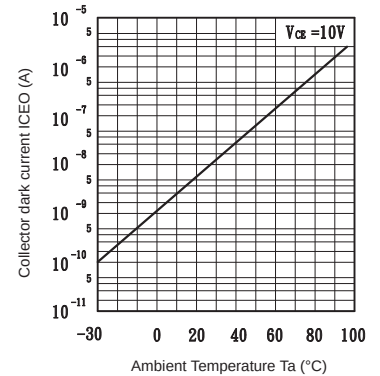


Fig.10 Response Time vs. Load Resistance

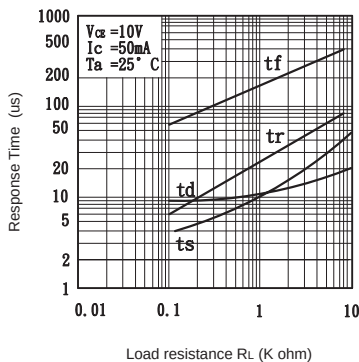
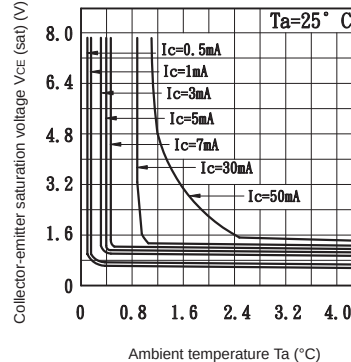


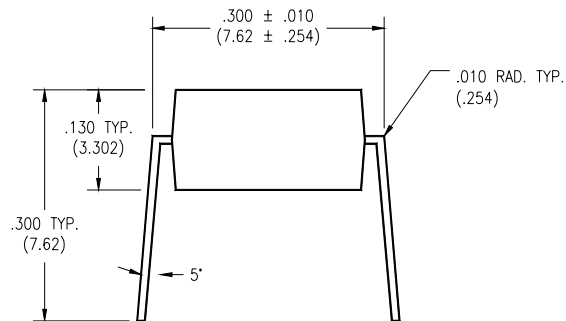
Fig.11 Collector-emitter Saturation Voltage vs. Forward current



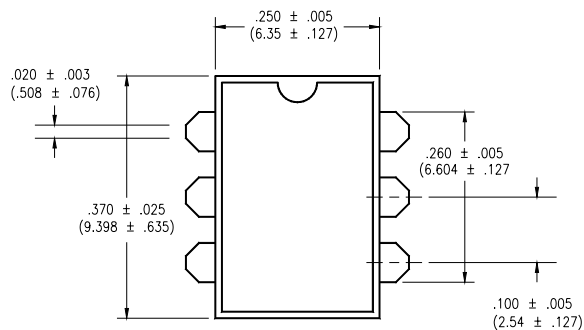


MECHANICAL DIMENSIONS

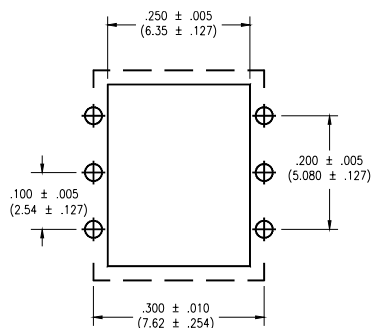
6 PIN DUAL IN-LINE PACKAGE



END VIEW

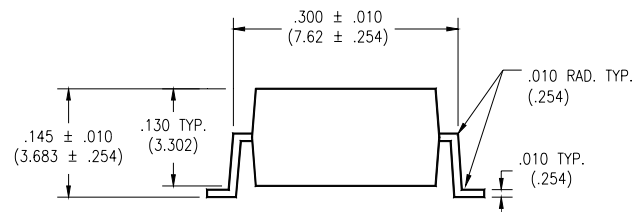


TOP VIEW

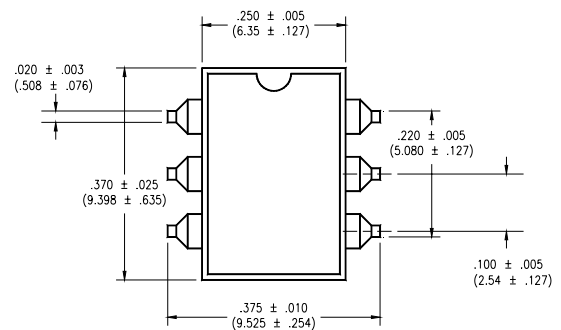


BOTTOM VIEW/
BOARD PATTERN

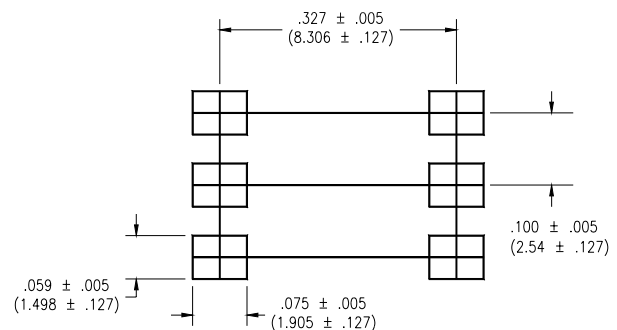
6 PIN SURFACE MOUNT DEVICE



END VIEW



TOP VIEW



BOTTOM VIEW/
BOARD PATTERN